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Hex Inverter Schmitt Trigger

High-Performance Silicon-Gate CMOS

The MC74AC14/74ACT14 contains six logic inverters which accept standard CMOS Input signals (TTL levels for MC74ACT14) and provide standard CMOS output levels. They are capable of transforming slowly changing input signals into sharply defined, jitter-free output signals. In addition, they have a greater noise margin then conventional inverters.

The MC74AC14/74ACT14 has hysteresis between the positive–going and negative–going input thresholds (typically 1.0 V) which is determined internally by transistor ratios and is essentially insensitive to temperature and supply voltage variations.

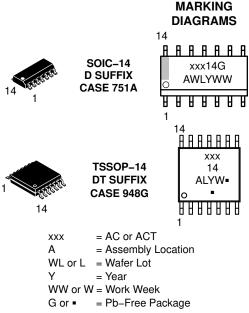
Features

- Schmitt Trigger Inputs
- Outputs Source/Sink 24 mA
- MC74ACT14 Has TTL Compatible Inputs
- NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant



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(Note: Microdot may be in either location)

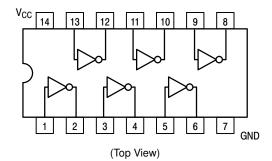


Figure 1. Pinout: 14-Lead Packages **Conductors**

FUNCTION TABLE

| Input | Output |
|--------|--------|
| Α | 0 |
| L H | H L |

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 5 of this data sheet.

MAXIMUM RATINGS

| Symbol | Paramet | er | Value | Unit |
|-----------------------|--|--|-----------------------------------|------|
| V _{CC} | DC Supply Voltage | | -0.5 to +7.0 | V |
| VI | DC Input Voltage | | $-0.5 \le V_I \le V_{CC} + 0.5$ | V |
| V _O | DC Output Voltage | (Note 1) | $-0.5 \le V_{O} \le V_{CC} + 0.5$ | V |
| I _{IK} | DC Input Diode Current | | ±20 | mA |
| l _{OK} | DC Output Diode Current | | ±50 | mA |
| Io | DC Output Sink/Source Current | | ±50 | mA |
| I _{CC} | DC Supply Current per Output Pin | | ±50 | mA |
| I _{GND} | DC Ground Current per Output Pin | | ±50 | mA |
| T _{STG} | Storage Temperature Range | | -65 to +150 | °C |
| TL | Lead temperature, 1 mm from Case for | r 10 Seconds | 260 | °C |
| TJ | Junction temperature under Bias | | + 150 | °C |
| θ_{JA} | Thermal Resistance (Note 2) | SOIC TSSOP | 125 170 | °C/W |
| P _D | Power Dissipation in Still Air at 85°C | SOIC TSSOP | 125 170 | mW |
| MSL | Moisture Sensitivity | | Level 1 | |
| F _R | Flammability Rating | Oxygen Index: 30% – 35% | UL 94 V-0 @ 0.125 in | |
| V _{ESD} | ESD Withstand Voltage | Human Body Model (Note 3) Machine Model (Note 4) Charged Device Model (Note 5) | > 2000 > 200 > 1000 | V |
| I _{Latch-Up} | Latch-Up Performance Above V _{CC} a | and Below GND at 85°C (Note 6) | ±100 | mA |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1. I_O absolute maximum rating must be observed.
- 2. The package thermal impedance is calculated in accordance with JESD51–7.
- 3. Tested to EIA/JESD22-A114-A.
- 4. Tested to EIA/JESD22-A115-A.
- 5. Tested to JESD22-C101-A.
- 6. Tested to EIA/JESD78.

RECOMMENDED OPERATING CONDITIONS

| Symbol | Parameter | | Min | Тур | Max | Unit |
|------------------------------------|--|-------------------------|-----|-----|-----------------|------|
| | Overal - Valle as | 'AC | 2.0 | 5.0 | 6.0 | ., |
| V _{CC} | Supply Voltage | 'ACT | 4.5 | 5.0 | 5.5 | V |
| V _{in} , V _{out} | DC Input Voltage, Output Voltage (Ref. to GND) | · | 0 | _ | V _{CC} | V |
| | | V _{CC} @ 3.0 V | | 150 | - | |
| t _r , t _f | Input Rise and Fall Time (Note 1) 'AC Devices except Schmitt Inputs | V _{CC} @ 4.5 V | - | 40 | - | ns/V |
| | | V _{CC} @ 5.5 V | - | 25 | - | |
| | Input Rise and Fall Time (Note 2) | V _{CC} @ 4.5 V | | 10 | - | |
| t _r , t _f | 'ACT Devices except Schmitt Inputs | V _{CC} @ 5.5 V | - | 8.0 | - | ns/V |
| TJ | Junction Temperature (PDIP) | | - | _ | 140 | °C |
| T _A | Operating Ambient Temperature Range | | -40 | 25 | 85 | °C |
| I _{OH} | Output Current – High | | _ | _ | -24 | mA |
| I _{OL} | Output Current – Low | | _ | _ | 24 | mA |

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

- V_{in} from 30% to 70% V_{CC}; see individual Data Sheets for devices that differ from the typical input rise and fall times.
 V_{in} from 0.8 V to 2.0 V; see individual Data Sheets for devices that differ from the typical input rise and fall times.

DC CHARACTERISTICS

| | | | 74 | AC | 74AC | | |
|------------------|-----------------------------------|------------------------|-------------------------|----------------------|---------------------------------|------|---|
| Symbol | Parameter | V _{CC} (V) | T _A = - | -25°C | T _A = -40°C to +85°C | Unit | Conditions |
| | | (*) | Тур | G | uaranteed Limits | | |
| V _{OH} | Minimum High Level Output Voltage | 3.0 4.5 5.5 | 2.99 4.49 5.49 | 2.9 4.4 5.4 | 2.9 4.4 5.4 | V | I _{OUT} = -50 μA |
| | | 3.0 4.5 5.5 | - - - | 2.56 3.86 4.86 | 2.46 3.76 4.76 | V | * V _{IN} = V _{IL} or V _{IH} -12 mA $_{OH}$ -24 mA $_{-24}$ mA |
| V _{OL} | Maximum Low Level Output Voltage | 3.0 4.5 5.5 | 0.002 0.001 0.001 | 0.1 0.1 0.1 | 0.1 0.1 0.1 | V | I _{OUT} = 50 μA |
| | | 3.0 4.5 5.5 | - - - | 0.36 0.36 0.36 | 0.44 0.44 0.44 | V | * V _{IN} = V _{IL} or V _{IH} 12 mA I OL 24 mA 24 mA |
| I _{IN} | Maximum Input Leakage Current | 5.5 | _ | ±0.1 | ±1.0 | μΑ | V _I = V _{CC} , GND |
| I _{OLD} | †Minimum Dynamic Output Current | 5.5 | - | - | 75 | mA | V _{OLD} = 1.65 V Max |
| I _{OHD} | | 5.5 | - | - | - 75 | mA | V _{OHD} = 3.85 V Min |
| Icc | Maximum Quiescent Supply Current | 5.5 | _ | 4.0 | 40 | μΑ | $V_{IN} = V_{CC}$ or GND |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

*All outputs loaded; thresholds on input associated with output under test.

NOTE: I_{IN} and I_{CC} @ 3.0 V are guaranteed to be less than or equal to the respective limit @ 5.5 V V_{CC}.

AC CHARACTERISTICS

| | | | 74AC | | | 74AC | | | |
|------------------|-------------------|--------------------------|---------------------|-----------------------|--------------|---|----------------------|------|---------------|
| Symbol | Parameter | V _{CC} * (V) | T _A = +2 | 25°C C _L = | 50 pF | T _A = -4 +85°C C _I | 10°C to _ = 50 pF | Unit | Figure No. |
| | | | Min | Тур | Max | Min | Max | | |
| t _{PLH} | Propagation Delay | 3.3 5.0 | 1.5 1.5 | 9.5 7.0 | 13.5 10.0 | 1.5 1.5 | 15.0 11.0 | ns | 3–5 |
| t _{PHL} | Propagation Delay | 3.3 5.0 | 1.5 1.5 | 7.5 6.0 | 11.5 8.5 | 1.5 1.5 | 13.0 9.5 | ns | 3–5 |

^{*}Voltage Range 3.3 V is 3.3 V ± 0.3 V. Voltage Range 5.0 V is 5.0 V ± 0.5 V.

[†]Maximum test duration 2.0 ms, one output loaded at a time.

INPUT CHARACTERISTICS (unless otherwise specified)

| Symbol | Parameter | V _{CC} (V) | 74AC | 74ACT | | Test Conditions |
|---------------------|----------------------------|---------------------|-------------------|-----------------|---|-----------------------------|
| V _{t+} | Maximum Positive Threshold | 3.0 4.5 5.5 | 2.2 3.2 3.9 | - 2.0 2.0 | V | T _A = Worst Case |
| V _t _ | Minimum Negative Threshold | 3.0 4.5 5.5 | 0.5 0.9 1.1 | - 0.8 0.8 | V | T _A = Worst Case |
| V _{h(max)} | Maximum Hysteresis | 3.0 4.5 5.5 | 1.2 1.4 1.6 | - 1.2 1.2 | V | T _A = Worst Case |
| V _{h(min)} | Minimum Hysteresis | 3.0 4.5 5.5 | 0.3 0.4 0.5 | - 0.4 0.4 | V | T _A = Worst Case |

DC CHARACTERISTICS

| | | | 74 | CT | 74ACT | | |
|------------------|--|---------------------|--------------------|--------------|---------------------------------|------|--|
| Symbol | Parameter | V _{CC} (V) | T _A = - | +25°C | T _A = -40°C to +85°C | Unit | Conditions |
| | | | Тур | Gı | uaranteed Limits | | |
| V _{OH} | Minimum High Level Output Voltage | 4.5 5.5 | 4.49 5.49 | 4.4 5.4 | 4.4 5.4 | V | I _{OUT} = -50 μA |
| | | 4.5 5.5 | _ _ | 3.86 4.86 | 3.76 4.76 | V | $^*V_{IN} = V_{IL} \text{ or } V_{IH}$ $I_{OH} -24 \text{ mA}$ -24 mA |
| V _{OL} | Maximum Low Level Output Voltage | 4.5 5.5 | 0.001 0.001 | 0.1 0.1 | 0.1 0.1 | V | I _{OUT} = 50 μA |
| | | 4.5 5.5 | _ _ | 0.36 0.36 | 0.44 0.44 | V | $^*V_{IN} = V_{IL} \text{ or } V_{IH}$ $^{24} \text{ mA}$ $^{1}_{OL}$ $^{24} \text{ mA}$ |
| I _{IN} | Maximum Input Leakage Current | 5.5 | - | ±0.1 | ±1.0 | μΑ | V _I = V _{CC} , GND |
| ΔI_{CCT} | Additional Max. I _{CC} /Input | 5.5 | 0.6 | - | 1.5 | mA | $V_{I} = V_{CC} - 2.1 \text{ V}$ |
| I _{OLD} | †Minimum Dynamic Output Current | 5.5 | - | - | 75 | mA | V _{OLD} = 1.65 V Max |
| I _{OHD} | | 5.5 | - | _ | -75 | mA | V _{OHD} = 3.85 V Min |
| I _{CC} | Maximum Quiescent Supply Current | 5.5 | - | 4.0 | 40 | μΑ | $V_{IN} = V_{CC}$ or GND |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

*All outputs loaded; thresholds on input associated with output under test.

AC CHARACTERISTICS

| | | | 74ACT | | | 74ACT | | | |
|------------------|-------------------|--------------------------|---|-----|--|-------|------|---------------|-----|
| Symbol | Parameter | V _{CC} * (V) | V_{CC}^* $T_A = +25^{\circ}C C_L = 50 pF$ | | V_{CC}^* $T_A = +25^{\circ}C C_L = 50 pF$ $T_A = -40^{\circ}C to +85^{\circ}C C_L = 50 pF$ | | Unit | Figure No. | |
| | | | Min | Тур | Max | Min | Max | | |
| t _{PLH} | Propagation Delay | 5.0 | 1.5 | _ | 11.5 | 1.0 | 12.5 | ns | 3–5 |
| t _{PHL} | Propagation Delay | 5.0 | 1.5 | - | 10.0 | 1.0 | 11.0 | ns | 3–5 |

^{*}Voltage Range 5.0 V is 5.0 V ±0.5 V.

CAPACITANCE

| Symbol | Parameter | Value Typ | Unit | Test Conditions |
|-----------------|-------------------------------|-----------|------|-------------------------|
| C _{IN} | Input Capacitance | 4.5 | pF | V _{CC} = 5.0 V |
| C _{PD} | Power Dissipation Capacitance | 25 | pF | V _{CC} = 5.0 V |

[†]Maximum test duration 2.0 ms, one output loaded at a time.

ORDERING INFORMATION

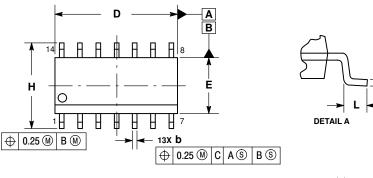
| Device | Package | Shipping [†] |
|----------------|-----------------------|-----------------------|
| MC74AC14DG | | 55 Units / Rail |
| MC74AC14DR2G | SOIC-14 (Pb-Free) | 2500 / Tape & Reel |
| NLV74AC14DR2G* | (2) | 2500 / Tape & Reel |
| MC74AC14DTR2G | TSSOP-14 (Pb-Free) | 2500 / Tape & Reel |
| MC74ACT14DG | SOIC-14 | 55 Units / Rail |
| MC74ACT14DR2G | (Pb-Free) | 2500 / Tape & Reel |
| MC74ACT14DTR2G | TSSOP-14 (Pb-Free) | 2500 / Tape & Reel |

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

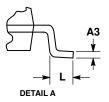
^{*}NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable.

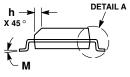
PACKAGE DIMENSIONS

SOIC-14 NB CASE 751A-03 ISSUE K



- e





NOTES:

- NOTES:

 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.

 2. CONTROLLING DIMENSION: MILLIMETERS.

 3. DIMENSION & DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION. SHALL BE 0.13 TOTAL IN EXCESS OF AT MAXIMUM MATERIAL CONDITION.

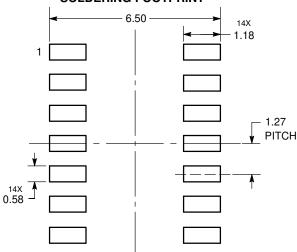
 4. DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRUSIONS.

 5. MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.

| | MILLIN | IETERS | INC | HES |
|-----|--------|--------|-------|-------|
| DIM | MIN | MAX | MIN | MAX |
| Α | 1.35 | 1.75 | 0.054 | 0.068 |
| A1 | 0.10 | 0.25 | 0.004 | 0.010 |
| A3 | 0.19 | 0.25 | 0.008 | 0.010 |
| b | 0.35 | 0.49 | 0.014 | 0.019 |
| D | 8.55 | 8.75 | 0.337 | 0.344 |
| Ε | 3.80 | 4.00 | 0.150 | 0.157 |
| е | 1.27 | BSC | 0.050 | BSC |
| Н | 5.80 | 6.20 | 0.228 | 0.244 |
| h | 0.25 | 0.50 | 0.010 | 0.019 |
| L | 0.40 | 1.25 | 0.016 | 0.049 |
| М | 0 ° | 7° | 0 ° | 7° |

SOLDERING FOOTPRINT*

C SEATING PLANE

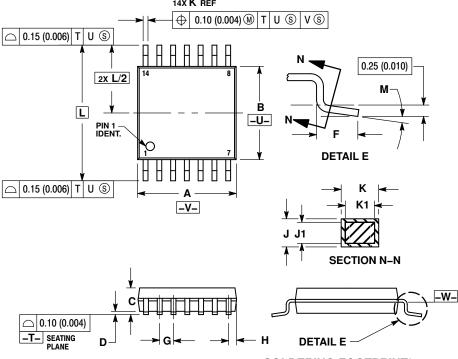


DIMENSIONS: MILLIMETERS

^{*}For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

PACKAGE DIMENSIONS

TSSOP-14 CASE 948G **ISSUE B**



- NOTES:
 1. DIMENSIONING AND TOLERANCING PER
- ANSI Y14.5M, 1982. CONTROLLING DIMENSION: MILLIMETER.
- DIMENSION A DOES NOT INCLUDE MOLD FLASH. PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT
- EXCEED 0.15 (0.006) PER SIDE.

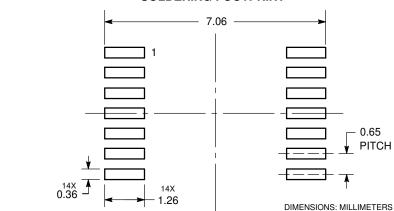
 DIMENSION B DOES NOT INCLUDE

 INTERLEAD FLASH OR PROTRUSION.

 INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
 DIMENSION K DOES NOT INCLUDE DAMBAR
 - PROTRUSION. ALLOWABLE DAMBAR
 PROTRUSION SHALL BE 0.08 (0.003) TOTAL
 IN EXCESS OF THE K DIMENSION AT
 MAXIMUM MATERIAL CONDITION.
- TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
- DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-

| | MILLIMETERS | | INCHES | | |
|-----|-------------|------|--------|-------|--|
| DIM | MIN | MAX | MIN | MAX | |
| Α | 4.90 | 5.10 | 0.193 | 0.200 | |
| В | 4.30 | 4.50 | 0.169 | 0.177 | |
| С | | 1.20 | | 0.047 | |
| D | 0.05 | 0.15 | 0.002 | 0.006 | |
| F | 0.50 | 0.75 | 0.020 | 0.030 | |
| G | 0.65 | BSC | 0.026 | BSC | |
| Н | 0.50 | 0.60 | 0.020 | 0.024 | |
| J | 0.09 | 0.20 | 0.004 | 0.008 | |
| J1 | 0.09 | 0.16 | 0.004 | 0.006 | |
| K | 0.19 | 0.30 | 0.007 | 0.012 | |
| K1 | 0.19 | 0.25 | 0.007 | 0.010 | |
| L | 6.40 | BSC | 0.252 | BSC | |
| М | 0 ° | 8 ° | 0 ° | 8 ° | |

SOLDERING FOOTPRINT*



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